Docket No.: 50232-074 **PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277

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Kazushi SANO, et al. : Confirmation Number: 6277

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Serial No.: Divisional of :

Appln. Serial No. 09/741,023 : Group Art Unit: Not yet assigned

Filed: August 05, 2003 : Examiner: Not yet assigned

For: COPPER PARTICLE CLUSTERS AND POWDER CONTAINING THE SAME

SUITABLE AS CONDUCTIVE FILLER OF CONDUCTIVE PASTE

## TRANSMITTAL OF FORMAL DRAWINGS

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Submitted herewith are six (06) sheets of formal drawings as corrected and filed in parent Application Serial No. 09/741,024.

Respectfully submitted,

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Date: August 5, 2003